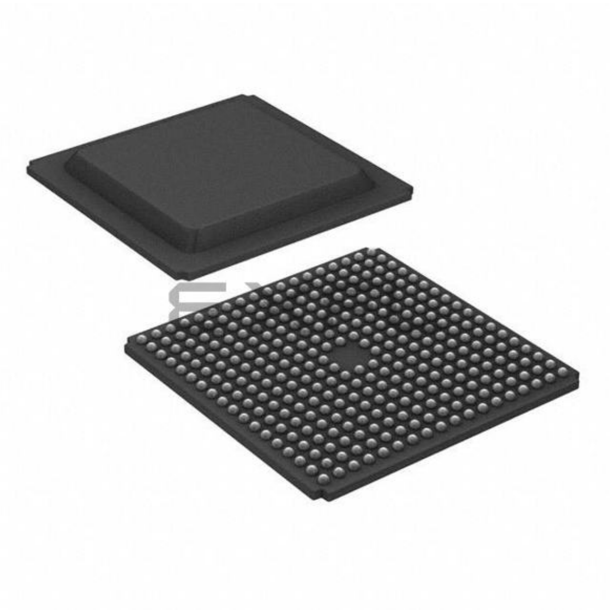

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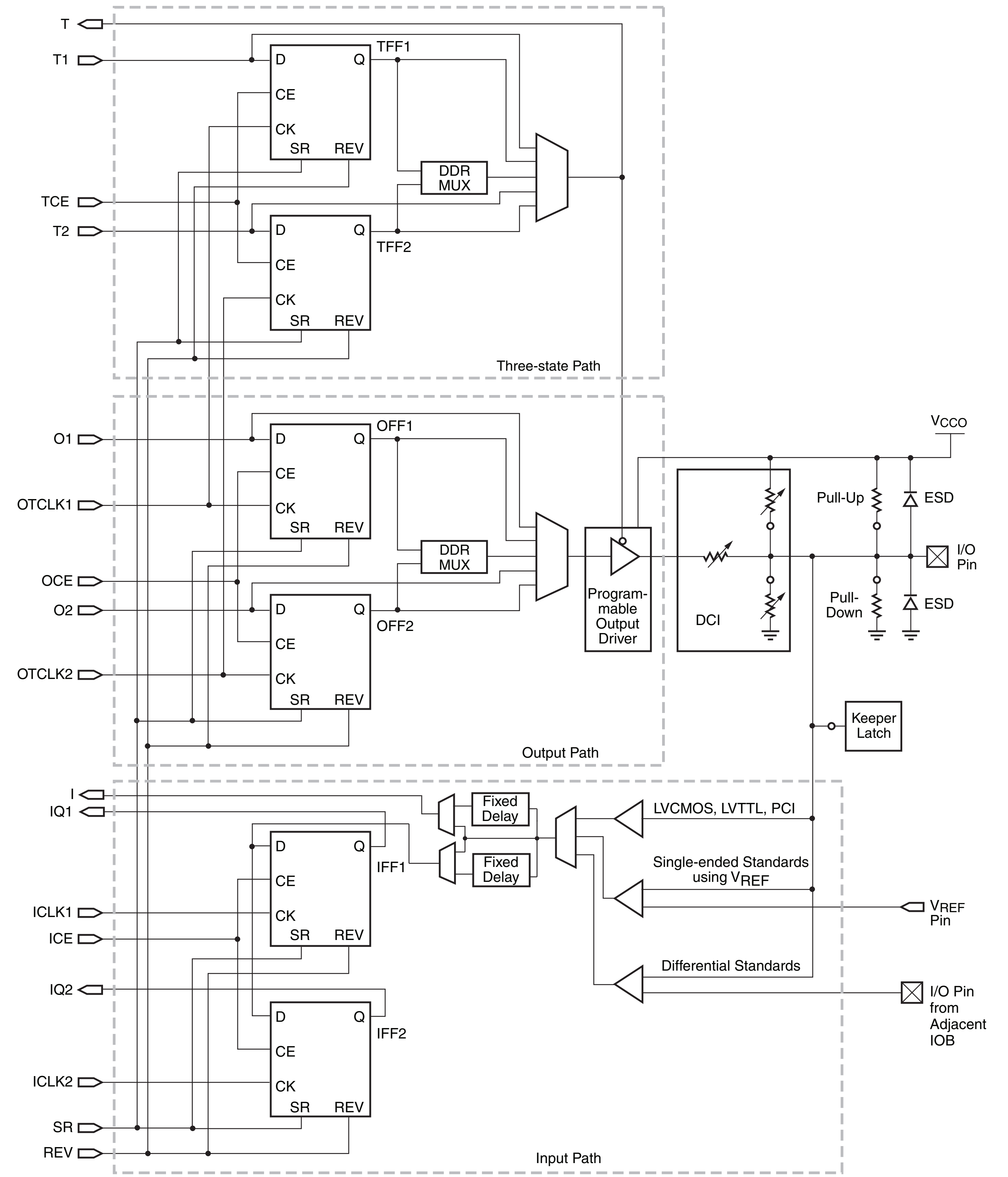
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

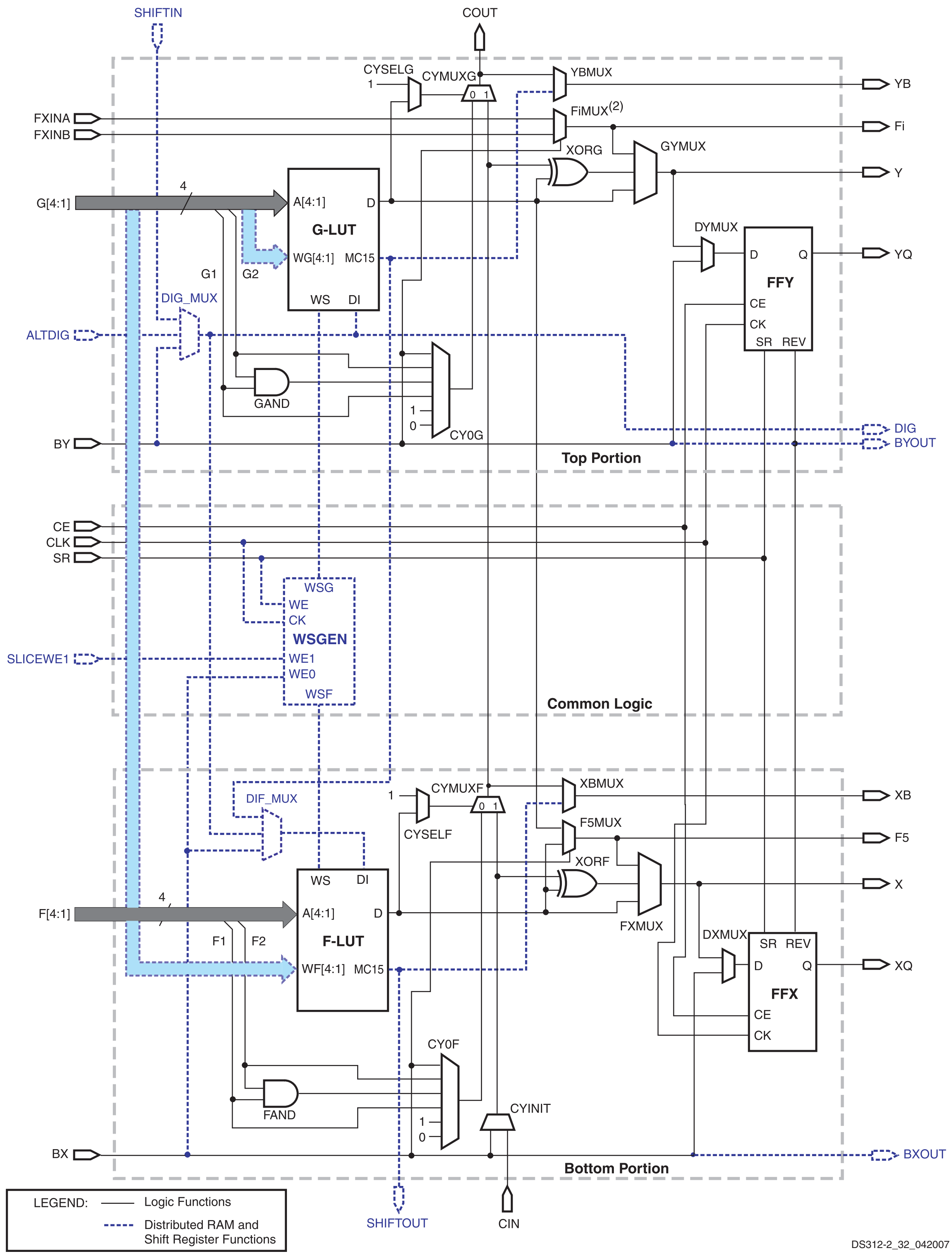
The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	3328
Number of Logic Elements/Cells	29952
Total RAM Bits	589824
Number of I/O	221
Number of Gates	1500000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	320-BGA
Supplier Device Package	320-FBGA (19x19)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s1500-4fgg320i



Note: All IOB signals originating from the FPGA's internal logic have an optional polarity inverter.

Figure 7: **Simplified IOB Diagram**



Notes:

1. Options to invert signal polarity as well as other options that enable lines for various functions are not shown.
2. The index i can be 6, 7, or 8, depending on the slice. In this position, the upper right-hand slice has an F8MUX, and the upper left-hand slice has an F7MUX. The lower right-hand and left-hand slices both have an F6MUX.

Figure 12: **Simplified Diagram of the Left-Hand SLICEM**

Function Generator

Each of the two LUTs (F and G) in a slice have four logic inputs (A1-A4) and a single output (D). This permits any four-variable Boolean logic operation to be programmed into them. Furthermore, wide function multiplexers can be used to effectively combine LUTs within the same CLB or across different CLBs, making logic functions with still more input variables possible.

The LUTs in both the right-hand and left-hand slice-pairs not only support the logic functions described above, but also can function as ROM that is initialized with data at the time of configuration.

The LUTs in the left-hand slice-pair (even-numbered columns such as X0 in Figure 11) of each CLB support two additional functions that the right-hand slice-pair (odd-numbered columns such as X1) do not.

First, it is possible to program the “left-hand LUTs” as distributed RAM. This type of memory affords moderate amounts of data buffering anywhere along a data path. One left-hand LUT stores 16 bits. Multiple left-hand LUTs can be combined in various ways to store larger amounts of data. A dual port option combines two LUTs so that memory access is possible from two independent data lines. A Distributed ROM option permits pre-loading the memory with data during FPGA configuration.

Second, it is possible to program each left-hand LUT as a 16-bit shift register. Used in this way, each LUT can delay serial data anywhere from one to 16 clock cycles. The four left-hand LUTs of a single CLB can be combined to produce delays up to 64 clock cycles. The SHIFTIN and SHIFTOUT lines cascade LUTs to form larger shift registers. It is also possible to combine shift registers across more than one CLB. The resulting programmable delays can be used to balance the timing of data pipelines.

Block RAM Overview

All Spartan-3 devices support block RAM, which is organized as configurable, synchronous 18Kbit blocks. Block RAM stores relatively large amounts of data more efficiently than the distributed RAM feature described earlier. (The latter is better suited for buffering small amounts of data anywhere along signal paths.) This section describes basic Block RAM functions. For more information, refer to the chapter entitled “Using Block RAM” in UG331.

The aspect ratio—i.e., width vs. depth—of each block RAM is configurable. Furthermore, multiple blocks can be cascaded to create still wider and/or deeper memories.

A choice among primitives determines whether the block RAM functions as dual- or single-port memory. A name of the form RAMB16_S[w_A]_S[w_B] calls out the dual-port primitive, where the integers w_A and w_B specify the total data path width at ports w_A and w_B, respectively. Thus, a RAMB16_S9_S18 is a dual-port RAM with a 9-bit-wide Port A and an 18-bit-wide Port B. A name of the form RAMB16_S[w] identifies the single-port primitive, where the integer w specifies the total data path width of the lone port. A RAMB16_S18 is a single-port RAM with an 18-bit-wide port. Other memory functions—e.g., FIFOs, data path width conversion, ROM, etc.—are readily available using the CORE Generator™ software, part of the Xilinx development software.

Table 13: **Block RAM Port Signals *(Cont'd)***

Signal Description	Port A Signal Name	Port B Signal Name	Direction	Function
Data Output Bus	DOA	DOB	Output	Basic data access occurs whenever WE is inactive. The DO outputs mirror the data stored in the addressed memory location. Data access with WE asserted is also possible if one of the following two attributes is chosen: WRITE_FIRST and READ_FIRST. WRITE_FIRST simultaneously presents the new input data on the DO output port and writes the data to the address RAM location. READ_FIRST presents the previously stored RAM data on the DO output port while writing new data to RAM. A third attribute, NO_CHANGE, latches the DO outputs upon the assertion of WE. It is possible to configure a port's total data path width (w) to be 1, 2, 4, 9, 18, or 36 bits. This selection applies to both the DI and DO paths. See the DI signal description.
Parity Data Output(s)	DOPA	DOPB	Output	Parity inputs represent additional bits included in the data input path to support error detection. The number of parity bits "p" included in the DI (same as for the DO bus) depends on a port's total data path width (w). See Table 14.
Write Enable	WEA	WEB	Input	When asserted together with EN, this input enables the writing of data to the RAM. In this case, the data access attributes WRITE_FIRST, READ_FIRST or NO_CHANGE determines if and how data is updated on the DO outputs. See the DO signal description. When WE is inactive with EN asserted, read operations are still possible. In this case, a transparent latch passes data from the addressed memory location to the DO outputs.
Clock Enable	ENA	ENB	Input	When asserted, this input enables the CLK signal to synchronize Block RAM functions as follows: the writing of data to the DI inputs (when WE is also asserted), the updating of data at the DO outputs as well as the setting/resetting of the DO output latches. When de-asserted, the above functions are disabled.
Set/Reset	SSRA	SSRB	Input	When asserted, this pin forces the DO output latch to the value that the SRVAL attribute is set to. A Set/Reset operation on one port has no effect on the other ports functioning, nor does it disturb the memory's data contents. It is synchronized to the CLK signal.
Clock	CLKA	CLKB	Input	This input accepts the clock signal to which read and write operations are synchronized. All associated port inputs are required to meet setup times with respect to the clock signal's active edge. The data output bus responds after a clock-to-out delay referenced to the clock signal's active edge.

Port Aspect Ratios

On a given port, it is possible to select a number of different possible widths ($w - p$) for the DI/DO buses as shown in Table 14. These two buses always have the same width. This data bus width selection is independent for each port. If the data bus width of Port A differs from that of Port B, the Block RAM automatically performs a bus-matching function. When data are written to a port with a narrow bus, then read from a port with a wide bus, the latter port will effectively combine "narrow" words to form "wide" words. Similarly, when data are written into a port with a wide bus, then read from a port with a narrow bus, the latter port will divide "wide" words to form "narrow" words. When the data bus width is eight bits or greater, extra parity bits become available. The width of the total data path (w) is the sum of the DI/DO bus width and any parity bits (p).

The width selection made for the DI/DO bus determines the number of address lines according to the relationship expressed below:

$$r = 14 - [\log(w-p)/\log(2)] \qquad \textit{Equation 1}$$

In turn, the number of address lines delimits the total number (n) of addressable locations or depth according to the following equation:

$$n = 2^r \qquad \textit{Equation 2}$$

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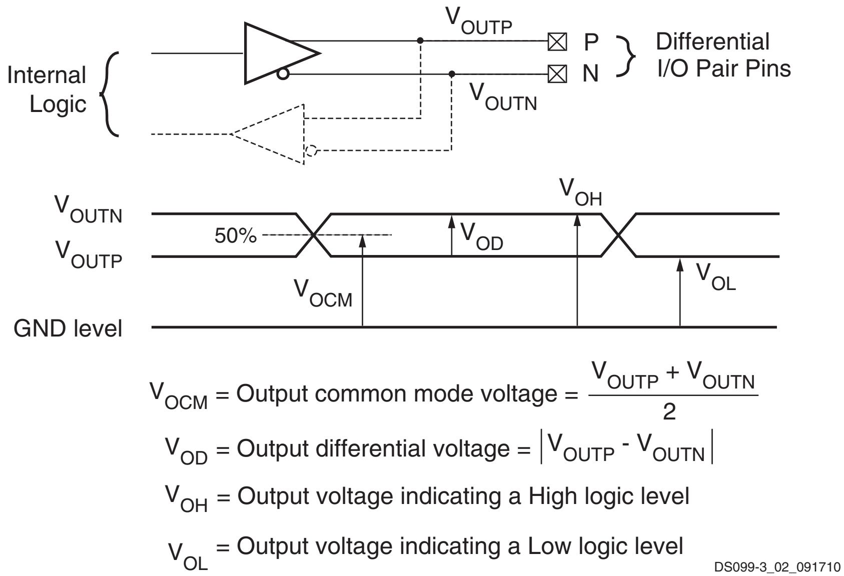

Figure 33: **Differential Output Voltages**

Table 38: **DC Characteristics of User I/Os Using Differential Signal Standards**

Signal Standard	Mask[3] Revision	V_{OD}			V_{OCM}			V_{OH}	V_{OL}
		Min (mV)	Typ (mV)	Max (mV)	Min (V)	Typ (V)	Max (V)	Min (V)	Max (V)
LDT_25 (ULVDS_25)	All	430[4]	600	670	0.495	0.600	0.715	0.71	0.50
LVDS_25	All	100	–	600	0.80	–	1.6	0.85	1.55
	‘E’	200	–	500	1.0	–	1.5	1.10	1.40
BLVDS_25[5]	All	250	350	450	–	1.20	–	–	–
LVDSEXT_25	All	100	–	600	0.80	–	1.6	0.85	1.55
	‘E’	300	–	700	1.0	–	1.5	1.15	1.35
LVPECL_25[5]	All	–	–	-	–	–	-	1.35	1.005
RSDS_25[6]	All	100	–	600	0.80	–	1.6	0.85	1.55
	‘E’	200	–	500	1.0	–	1.5	1.10	1.40
DIFF_HSTL_II_18	All	–	–	–	–	–	–	$V_{CCO} - 0.40$	0.40
DIFF_SSTL2_II	All	–	–	–	–	–	–	$V_{TT} + 0.80$	$V_{TT} - 0.80$

Notes:

1. The numbers in this table are based on the conditions set forth in Table 32 and Table 37.
2. Output voltage measurements for all differential standards are made with a termination resistor (R_T) of 100Ω across the N and P pins of the differential signal pair.
3. Mask revision E devices have tighter output ranges but can be used in any design that was in a previous revision. See Mask and Fab Revisions, page 58.
4. This value must be compatible with the receiver to which the FPGA’s output pair is connected.
5. Each LVPECL_25 or BLVDS_25 output-pair requires three external resistors for proper output operation as shown in Figure 34. Each LVPECL_25 or BLVDS_25 input-pair uses a 100W termination resistor at the receiver.
6. Only one of the differential standards RSDS_25, LDT_25, LVDS_25, and LVDSEXT_25 may be used for outputs within a bank. Each differential standard input-pair requires an external 100Ω termination resistor.

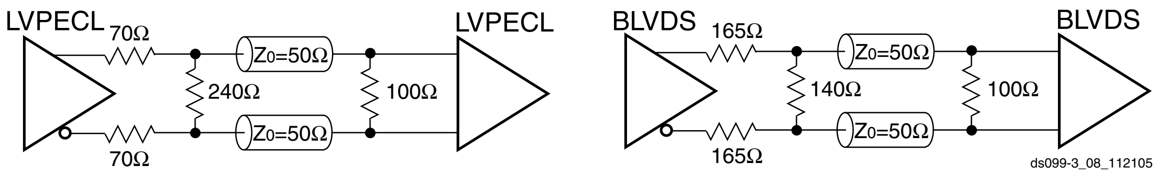

Figure 34: **External Termination Required for LVPECL and BLVDS Output and Input**

Miscellaneous DCM Timing

Table 64: **Miscellaneous DCM Timing**

Symbol	Description	DLL Frequency Mode	Temperature Range		Units
			Commercial	Industrial	
DCM_INPUT_CLOCK_STOP	Maximum duration that the CLKIN and CLKFB signals can be stopped[1,2]	Any	100	100	ms
DCM_RST_PW_MIN	Minimum duration of a RST pulse width	Any	3	3	CLKIN cycles
DCM_RST_PW_MAX[3]	Maximum duration of a RST pulse width[1,2]	Low	N/A	N/A	seconds
		High	N/A	10	seconds
DCM_CONFIG_LAG_TIME[4]	Maximum duration from V_{CCINT} applied to FPGA configuration successfully completed (DONE pin goes High) and clocks applied to DCM DLL[1,2]	Low	N/A	N/A	minutes
		High	N/A	10	minutes

Notes:

1. These limits only apply to applications that use the DCM DLL outputs (CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV). The DCM DFS outputs (CLKFX, CLKFX180) are unaffected. Required due to effects of device cooling: see “Momentarily Stopping CLKIN” in Chapter 3 of UG331.
2. Industrial-temperature applications that use the DLL in High-Frequency mode must use a continuous or increasing operating frequency. The DLL under these conditions does not support reducing the operating frequency once establishing an initial operating frequency.
3. This specification is equivalent to the Virtex-4 FPGA DCM_RESET specification.
4. This specification is equivalent to the Virtex-4 FPGA TCONFIG specification.

Table 71: **Dual-Purpose Pins Used in Master or Slave Serial Mode**

Pin Name	Direction	Description
DIN	Input	**Serial Data Input:** During the Master or Slave Serial configuration modes, DIN is the serial configuration data input, and all data is synchronized to the rising CCLK edge. After configuration, this pin is available as a user I/O. This signal is located in Bank 4 and its output voltage determined by VCCO_4. The BitGen option ***Persist*** permits this pin to retain its configuration function in the User mode.
DOUT	Output	**Serial Data Output:** In a multi-FPGA design where all the FPGAs use serial mode, connect the DOUT output of one FPGA—in either Master or Slave Serial mode—to the DIN input of the next FPGA—in Slave Serial mode—so that configuration data passes from one to the next, in daisy-chain fashion. This "daisy chain" permits sequential configuration of multiple FPGAs. This signal is located in Bank 4 and its output voltage determined by VCCO_4. The BitGen option ***Persist*** permits this pin to retain its configuration function in the User mode.
INIT_B	Bidirectional (open-drain)	**Initializing Configuration Memory/Configuration Error:** Just after power is applied, the FPGA produces a Low-to-High transition on this pin indicating that initialization (*i.e.*, clearing) of the configuration memory has finished. Before entering the User mode, this pin functions as an open-drain output, which requires a pull-up resistor in order to produce a High logic level. In a multi-FPGA design, tie (wire AND) the INIT_B pins from all FPGAs together so that the common node transitions High only after all of the FPGAs have been successfully initialized. Externally holding this pin Low beyond the initialization phase delays the start of configuration. This action stalls the FPGA at the configuration step just before the mode select pins are sampled. During configuration, the FPGA indicates the occurrence of a data (i.e., CRC) error by asserting INIT_B Low. This signal is located in Bank 4 and its output voltage determined by VCCO_4. The BitGen option ***Persist*** permits this pin to retain its configuration function in the User mode.

	I/O Bank 4 (VCCO_4)				*I/O Bank 5 (VCCO_5)*			
	High Nibble				*Low Nibble*			
Configuration Data Byte	**D0**	**D1**	**D2**	**D3**	**D4**	**D5**	**D6**	**D7**
0xFC =	1	1	1	1	1	1	0	0
	(MSB)							***(LSB)***

Figure 41: **Configuration Data Byte Mapping to D0-D7 Bits**

Parallel Configuration Modes (SelectMAP)

This section describes the dual-purpose configuration pins used during the Master and Slave Parallel configuration modes, sometimes also called the SelectMAP modes. In both Master and Slave Parallel configuration modes, D0-D7 form the byte-wide configuration data input. See Table 75 for Mode Select pin settings required for Parallel modes.

As shown in Figure 41, D0 is the most-significant bit while D7 is the least-significant bit. Bits D0-D3 form the high nibble of the byte and bits D4-D7 form the low nibble.

In the Parallel configuration modes, both the VCCO_4 and VCCO_5 voltage supplies are required and must both equal the voltage of the attached configuration device, typically either 2.5V or 3.3V.

Assert Low both the chip-select pin, CS_B, and the read/write control pin, RDWR_B, to write the configuration data byte presented on the D0-D7 pins to the FPGA on a rising-edge of the configuration clock, CCLK. The order of CS_B and RDWR_B does not matter, although RDWR_B must be asserted throughout the configuration process. If RDWR_B is de-asserted during configuration, the FPGA aborts the configuration operation.

After configuration, these pins are available as general-purpose user I/O. However, the SelectMAP configuration interface is optionally available for debugging and dynamic reconfiguration. To use these SelectMAP pins after configuration, set the Persist bitstream generation option.

The Readback debugging option, for example, requires the Persist bitstream generation option. During Readback mode, assert CS_B Low, along with RDWR_B High, to read a configuration data byte from the FPGA to the D0-D7 bus on a rising CCLK edge. During Readback mode, D0-D7 are output pins.

In all the cases, the configuration data and control signals are synchronized to the rising edge of the CCLK clock signal.

HSWAP_EN: Disable Pull-up Resistors During Configuration

As shown in Table 76, a Low on this asynchronous pin enables pull-up resistors on all user I/Os not actively involved in the configuration process, although only until device configuration completes. A High disables the pull-up resistors during configuration, which is the desired state for some applications.

The dedicated configuration CONFIG pins (CCLK, DONE, PROG_B, HSWAP_EN, M2, M1, M0), the JTAG pins (TDI, TMS, TCK, TDO) and the INIT_B always have active pull-up resistors during configuration, regardless of the value on HSWAP_EN.

After configuration, HSWAP_EN becomes a "don't care" input and any pull-up resistors previously enabled by HSWAP_EN are disabled. If a user I/O in the application requires a pull-up resistor after configuration, place a PULLUP primitive on the associated I/O pin or, for some pins, set the associated bitstream generator option.

Table 76: **HSWAP_EN Encoding**

HSWAP_EN	Function
During Configuration	
0	Enable pull-up resistors on all pins not actively involved in the configuration process. Pull-ups are only active until configuration completes. See Table 79.
1	No pull-up resistors during configuration.
After Configuration, User Mode	
X	This pin has no function except during device configuration.

Notes:
1. X = don't care, either 0 or 1.

The Bitstream generator option HswapenPin determines whether a pull-up resistor to VCCAUX, a pull-down resistor, or no resistor is present on HSWAP_EN after configuration.

JTAG: Dedicated JTAG Port Pins

Table 77: **JTAG Pin Descriptions**

Pin Name	Direction	Description	Bitstream Generation Option
TCK	Input	**Test Clock:** The TCK clock signal synchronizes all boundary scan operations on its rising edge.	The BitGen option **TckPin** determines whether a pull-up resistor, pull-down resistor or no resistor is present.
TDI	Input	**Test Data Input:** TDI is the serial data input for all JTAG instruction and data registers. This input is sampled on the rising edge of TCK.	The BitGen option **TdiPin** determines whether a pull-up resistor, pull-down resistor or no resistor is present.
TMS	Input	**Test Mode Select:** The TMS input controls the sequence of states through which the JTAG TAP state machine passes. This input is sampled on the rising edge of TCK.	The BitGen option **TmsPin** determines whether a pull-up resistor, pull-down resistor or no resistor is present.
TDO	Output	**Test Data Output:** The TDO pin is the data output for all JTAG instruction and data registers. This output is sampled on the rising edge of TCK. The TDO output is an active totem-pole driver and is not like the open-collector TDO output on Virtex®-II Pro FPGAs.	The BitGen option **TdoPin** determines whether a pull-up resistor, pull-down resistor or no resistor is present.

These pins are dedicated connections to the four-wire IEEE 1532/IEEE 1149.1 JTAG port, shown in Figure 43 and described in Table 77. The JTAG port is used for boundary-scan testing, device configuration, application debugging, and possibly an additional serial port for the application. These pins are dedicated and are not available as user-I/O pins. Every package has four dedicated JTAG pins and these pins are powered by the +2.5V VCCAUX supply.

For additional information on JTAG configuration, see Boundary-Scan (JTAG) Mode, page 50.

Table 79: **Pin Behavior After Power-Up, During Configuration *(Cont'd)***

Pin Name	Configuration Mode Settings <M2:M1:M0>					Bitstream Configuration Option
	Serial Modes		SelectMap Parallel Modes		JTAG Mode <1:0:1>	
	Master <0:0:0>	Slave <1:1:1>	Master <0:1:1>	Slave <1:1:0>		
IO_Lxxy_#/ D5			D5 (I/O)	D5 (I/O)		Persist UnusedPin
IO_Lxxy_#/ D6			D6 (I/O)	D6 (I/O)		Persist UnusedPin
IO_Lxxy_#/ D7			D7 (I/O)	D7 (I/O)		Persist UnusedPin
IO_Lxxy_#/ CS_B			CS_B (I)	CS_B (I)		Persist UnusedPin
IO_Lxxy_#/ RDWR_B			RDWR_B (I)	RDWR_B (I)		Persist UnusedPin
IO_Lxxy_#/ BUSY/DOUT	DOUT (O)	DOUT (O)	BUSY (O)	BUSY (O)		Persist UnusedPin
DUAL: Dual-purpose configuration pins (INIT_B has a pull-up resistor to VCCO_4 or VCCO_BOTTOM always active during configuration, regardless of HSWAP_EN pin)						
IO_Lxxy_#/ INIT_B	INIT_B (I/OD)	INIT_B (I/OD)	INIT_B (I/OD)	INIT_B (I/OD)		UnusedPin
DCI: Digitally Controlled Impedance reference resistor input pins						
IO_Lxxy_#/ VRN_#						UnusedPin
IO/VRN_#						UnusedPin
IO_Lxxy_#/ VRP_#						UnusedPin
IO/VRP_#						UnusedPin
GCLK: Global clock buffer inputs						
IO_Lxxy_#/ GCLK0 through GCLK7						UnusedPin
VREF: I/O bank input reference voltage pins						
IO_Lxxy_#/ VREF_#						UnusedPin
IO/VREF_#						UnusedPin
CONFIG: Dedicated configuration pins (pull-up resistor to VCCAUX always active during configuration, regardless of HSWAP_EN pin)						
CCLK	CCLK (I/O)	CCLK (I)	CCLK (I/O)	CCLK (I)		CclkPin ConfigRate
PROG_B	PROG_B (I) (pull-up)	PROG_B (I) (pull-up)	PROG_B (I) (pull-up)	PROG_B (I) (pull-up)	PROG_B (I), Via JPROG_B instruction	ProgPin
DONE	DONE (I/OD)	DONE (I/OD)	DONE (I/OD)	DONE (I/OD)	DONE (I/OD)	DriveDone DonePin DonePipe
M2	M2=0 (I)	M2=1 (I)	M2=0 (I)	M2=1 (I)	M2=1 (I)	M2Pin
M1	M1=0 (I)	M1=1 (I)	M1=1 (I)	M1=1 (I)	M1=0 (I)	M1Pin
M0	M0=0 (I)	M0=1 (I)	M0=1 (I)	M0=0 (I)	M0=1 (I)	M0Pin
HSWAP_EN	HSWAP_EN (I)	HSWAP_EN (I)	HSWAP_EN (I)	HSWAP_EN (I)	HSWAP_EN (I)	HswapenPin

Table 89: **CP132 Package Pinout *(Cont'd)***

Bank	XC3S50 Pin Name	CP132 Ball	Type
6	IO_L22N_6	K1	I/O
6	IO_L22P_6	J3	I/O
6	IO_L23N_6	J2	I/O
6	IO_L23P_6	J1	I/O
6	IO_L24N_6/VREF_6	H3	VREF
6	IO_L24P_6	H2	I/O
6	IO_L40N_6	H1	I/O
6	IO_L40P_6/VREF_6	G3	VREF
7	IO_L01N_7/VRP_7	B2	DCI
7	IO_L01P_7/VRN_7	B1	DCI
7	IO_L21N_7	C1	I/O
7	IO_L21P_7	D3	I/O
7	IO_L22N_7	D1	I/O
7	IO_L22P_7	D2	I/O
7	IO_L23N_7	E2	I/O
7	IO_L23P_7	E3	I/O
7	IO_L24N_7	F3	I/O
7	IO_L24P_7	E1	I/O
7	IO_L40N_7/VREF_7	G1	VREF
7	IO_L40P_7	F2	I/O
0,1	VCCO_TOP	B12	VCCO
0,1	VCCO_TOP	A4	VCCO
0,1	VCCO_TOP	B8	VCCO
2,3	VCCO_RIGHT	D13	VCCO
2,3	VCCO_RIGHT	H13	VCCO
2,3	VCCO_RIGHT	M12	VCCO
4,5	VCCO_BOTTOM	N7	VCCO
4,5	VCCO_BOTTOM	P11	VCCO
4,5	VCCO_BOTTOM	N3	VCCO
6,7	VCCO_LEFT	G2	VCCO
6,7	VCCO_LEFT	L2	VCCO
6,7	VCCO_LEFT	C3	VCCO
N/A	GND	B4	GND
N/A	GND	B9	GND
N/A	GND	C2	GND
N/A	GND	C12	GND
N/A	GND	D14	GND
N/A	GND	F1	GND
N/A	GND	J14	GND
N/A	GND	L1	GND

Table 100: **FG456 Package Pinout *(Cont'd)***

Bank	3S400 Pin Name	3S1000, 3S1500, 3S2000 Pin Name	FG456 Pin Number	Type
1	IO_L15P_1	IO_L15P_1	E17	I/O
1	IO_L16N_1	IO_L16N_1	B17	I/O
1	IO_L16P_1	IO_L16P_1	C17	I/O
1	N.C. (◆)	IO_L19N_1	C16	I/O
1	N.C. (◆)	IO_L19P_1	D16	I/O
1	N.C. (◆)	IO_L22N_1	A16	I/O
1	N.C. (◆)	IO_L22P_1	B16	I/O
1	IO_L24N_1	IO_L24N_1	D15	I/O
1	IO_L24P_1	IO_L24P_1	E15	I/O
1	IO_L25N_1	IO_L25N_1	B15	I/O
1	IO_L25P_1	IO_L25P_1	A15	I/O
1	IO_L27N_1	IO_L27N_1	D14	I/O
1	IO_L27P_1	IO_L27P_1	E14	I/O
1	IO_L28N_1	IO_L28N_1	A14	I/O
1	IO_L28P_1	IO_L28P_1	B14	I/O
1	IO_L29N_1	IO_L29N_1	C13	I/O
1	IO_L29P_1	IO_L29P_1	D13	I/O
1	IO_L30N_1	IO_L30N_1	A13	I/O
1	IO_L30P_1	IO_L30P_1	B13	I/O
1	IO_L31N_1/VREF_1	IO_L31N_1/VREF_1	D12	VREF
1	IO_L31P_1	IO_L31P_1	E12	I/O
1	IO_L32N_1/GCLK5	IO_L32N_1/GCLK5	B12	GCLK
1	IO_L32P_1/GCLK4	IO_L32P_1/GCLK4	C12	GCLK
1	VCCO_1	VCCO_1	C15	VCCO
1	VCCO_1	VCCO_1	F15	VCCO
1	VCCO_1	VCCO_1	G12	VCCO
1	VCCO_1	VCCO_1	G13	VCCO
1	VCCO_1	VCCO_1	G14	VCCO
2	IO	IO	C22	I/O
2	IO_L01N_2/VRP_2	IO_L01N_2/VRP_2	C20	DCI
2	IO_L01P_2/VRN_2	IO_L01P_2/VRN_2	C21	DCI
2	IO_L16N_2	IO_L16N_2	D20	I/O
2	IO_L16P_2	IO_L16P_2	D19	I/O
2	IO_L17N_2	IO_L17N_2	D21	I/O
2	IO_L17P_2/VREF_2	IO_L17P_2/VREF_2	D22	VREF
2	IO_L19N_2	IO_L19N_2	E18	I/O
2	IO_L19P_2	IO_L19P_2	F18	I/O
2	IO_L20N_2	IO_L20N_2	E19	I/O
2	IO_L20P_2	IO_L20P_2	E20	I/O
2	IO_L21N_2	IO_L21N_2	E21	I/O

Table 103: **FG676 Package Pinout *(Cont'd)***

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
1	N.C. (◆)	IO_L18P_1	IO_L18P_1	IO_L18P_1	IO[(3)]	C18	I/O
1	IO_L19N_1	IO_L19N_1	IO_L19N_1	IO_L19N_1	IO_L19N_1	F17	I/O
1	IO_L19P_1	IO_L19P_1	IO_L19P_1	IO_L19P_1	IO_L19P_1	G17	I/O
1	IO_L22N_1	IO_L22N_1	IO_L22N_1	IO_L22N_1	IO_L22N_1	D17	I/O
1	IO_L22P_1	IO_L22P_1	IO_L22P_1	IO_L22P_1	IO_L22P_1	E17	I/O
1	N.C. (◆)	IO_L23N_1	IO_L23N_1	IO_L23N_1	IO_L23N_1	A17	I/O
1	N.C. (◆)	IO_L23P_1	IO_L23P_1	IO_L23P_1	IO_L23P_1	B17	I/O
1	IO_L24N_1	IO_L24N_1	IO_L24N_1	IO_L24N_1	IO_L24N_1	G16	I/O
1	IO_L24P_1	IO_L24P_1	IO_L24P_1	IO_L24P_1	IO_L24P_1	H16	I/O
1	IO_L25N_1	IO_L25N_1	IO_L25N_1	IO_L25N_1	IO_L25N_1	E16	I/O
1	IO_L25P_1	IO_L25P_1	IO_L25P_1	IO_L25P_1	IO_L25P_1	F16	I/O
1	N.C. (◆)	IO_L26N_1	IO_L26N_1	IO_L26N_1	IO_L26N_1	A16	I/O
1	N.C. (◆)	IO_L26P_1	IO_L26P_1	IO_L26P_1	IO_L26P_1	B16	I/O
1	IO_L27N_1	IO_L27N_1	IO_L27N_1	IO_L27N_1	IO_L27N_1	G15	I/O
1	IO_L27P_1	IO_L27P_1	IO_L27P_1	IO_L27P_1	IO_L27P_1	H15	I/O
1	IO_L28N_1	IO_L28N_1	IO_L28N_1	IO_L28N_1	IO_L28N_1	E15	I/O
1	IO_L28P_1	IO_L28P_1	IO_L28P_1	IO_L28P_1	IO_L28P_1	F15	I/O
1	IO_L29N_1	IO_L29N_1	IO_L29N_1	IO_L29N_1	IO_L29N_1	A15	I/O
1	IO_L29P_1	IO_L29P_1	IO_L29P_1	IO_L29P_1	IO_L29P_1	B15	I/O
1	IO_L30N_1	IO_L30N_1	IO_L30N_1	IO_L30N_1	IO_L30N_1	G14	I/O
1	IO_L30P_1	IO_L30P_1	IO_L30P_1	IO_L30P_1	IO_L30P_1	H14	I/O
1	IO_L31N_1/VREF_1	IO_L31N_1/VREF_1	IO_L31N_1/VREF_1	IO_L31N_1/VREF_1	IO_L31N_1/VREF_1	D14	VREF
1	IO_L31P_1	IO_L31P_1	IO_L31P_1	IO_L31P_1	IO_L31P_1	E14	I/O
1	IO_L32N_1/GCLK5	IO_L32N_1/GCLK5	IO_L32N_1/GCLK5	IO_L32N_1/GCLK5	IO_L32N_1/GCLK5	B14	GCLK
1	IO_L32P_1/GCLK4	IO_L32P_1/GCLK4	IO_L32P_1/GCLK4	IO_L32P_1/GCLK4	IO_L32P_1/GCLK4	C14	GCLK
1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	C16	VCCO
1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	C20	VCCO
1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	H17	VCCO
1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	H18	VCCO
1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	J14	VCCO
1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	J15	VCCO
1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	J16	VCCO
1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	VCCO_1	K14	VCCO
2	N.C. (◆)	N.C. (■)	IO	IO	IO	F22	I/O
2	IO_L01N_2/VRP_2	IO_L01N_2/VRP_2	IO_L01N_2/VRP_2	IO_L01N_2/VRP_2	IO_L01N_2/VRP_2	C25	DCI
2	IO_L01P_2/VRN_2	IO_L01P_2/VRN_2	IO_L01P_2/VRN_2	IO_L01P_2/VRN_2	IO_L01P_2/VRN_2	C26	DCI
2	IO_L02N_2	IO_L02N_2	IO_L02N_2	IO_L02N_2	IO_L02N_2	E23	I/O
2	IO_L02P_2	IO_L02P_2	IO_L02P_2	IO_L02P_2	IO_L02P_2	E24	I/O
2	IO_L03N_2/VREF_2	IO_L03N_2/VREF_2[(1)]	IO_L03N_2/VREF_2	IO_L03N_2/VREF_2	IO_L03N_2/VREF_2	D25	VREF[(1)]
2	IO_L03P_2	IO_L03P_2	IO_L03P_2	IO_L03P_2	IO_L03P_2	D26	I/O
2	N.C. (◆)	IO_L05N_2	IO_L05N_2	IO_L05N_2	IO_L05N_2	E25	I/O
2	N.C. (◆)	IO_L05P_2	IO_L05P_2	IO_L05P_2	IO_L05P_2	E26	I/O

Table 103: **FG676 Package Pinout *(Cont'd)***

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
5	IO_L29P_5/VREF_5	IO_L29P_5/VREF_5	IO_L29P_5/VREF_5	IO_L29P_5/VREF_5	IO_L29P_5/VREF_5	AE12	VREF
5	IO_L30N_5	IO_L30N_5	IO_L30N_5	IO_L30N_5	IO_L30N_5	Y13	I/O
5	IO_L30P_5	IO_L30P_5	IO_L30P_5	IO_L30P_5	IO_L30P_5	W13	I/O
5	IO_L31N_5/D4	IO_L31N_5/D4	IO_L31N_5/D4	IO_L31N_5/D4	IO_L31N_5/D4	AC13	DUAL
5	IO_L31P_5/D5	IO_L31P_5/D5	IO_L31P_5/D5	IO_L31P_5/D5	IO_L31P_5/D5	AB13	DUAL
5	IO_L32N_5/GCLK3	IO_L32N_5/GCLK3	IO_L32N_5/GCLK3	IO_L32N_5/GCLK3	IO_L32N_5/GCLK3	AE13	GCLK
5	IO_L32P_5/GCLK2	IO_L32P_5/GCLK2	IO_L32P_5/GCLK2	IO_L32P_5/GCLK2	IO_L32P_5/GCLK2	AD13	GCLK
5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	AD7	VCCO
5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	AD11	VCCO
5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	U13	VCCO
5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	V11	VCCO
5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	V12	VCCO
5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	V13	VCCO
5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	W9	VCCO
5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	VCCO_5	W10	VCCO
6	N.C. (◆)	N.C. (■)	IO	IO	IO	AA5	I/O
6	IO_L01N_6/VRP_6	IO_L01N_6/VRP_6	IO_L01N_6/VRP_6	IO_L01N_6/VRP_6	IO_L01N_6/VRP_6	AD2	DCI
6	IO_L01P_6/VRN_6	IO_L01P_6/VRN_6	IO_L01P_6/VRN_6	IO_L01P_6/VRN_6	IO_L01P_6/VRN_6	AD1	DCI
6	IO_L02N_6	IO_L02N_6	IO_L02N_6	IO_L02N_6	IO_L02N_6	AB4	I/O
6	IO_L02P_6	IO_L02P_6	IO_L02P_6	IO_L02P_6	IO_L02P_6	AB3	I/O
6	IO_L03N_6/VREF_6	IO_L03N_6/VREF_6	IO_L03N_6/VREF_6	IO_L03N_6/VREF_6	IO_L03N_6/VREF_6	AC2	VREF
6	IO_L03P_6	IO_L03P_6	IO_L03P_6	IO_L03P_6	IO_L03P_6	AC1	I/O
6	N.C. (◆)	IO_L05N_6	IO_L05N_6	IO_L05N_6	IO_L05N_6	AB2	I/O
6	N.C. (◆)	IO_L05P_6	IO_L05P_6	IO_L05P_6	IO_L05P_6	AB1	I/O
6	N.C. (◆)	IO_L06N_6	IO_L06N_6	IO_L06N_6	IO_L06N_6	Y7	I/O
6	N.C. (◆)	IO_L06P_6	IO_L06P_6	IO_L06P_6	IO_L06P_6	Y6	I/O
6	N.C. (◆)	IO_L07N_6	IO_L07N_6	IO_L07N_6	IO_L07N_6	AA4	I/O
6	N.C. (◆)	IO_L07P_6	IO_L07P_6	IO_L07P_6	IO_L07P_6	AA3	I/O
6	N.C. (◆)	IO_L08N_6	IO_L08N_6	IO_L08N_6	IO_L08N_6	Y5	I/O
6	N.C. (◆)	IO_L08P_6	IO_L08P_6	IO_L08P_6	IO_L08P_6	Y4	I/O
6	N.C. (◆)	IO_L09N_6/VREF_6	IO_L09N_6/VREF_6	IO_L09N_6/VREF_6	IO_L09N_6/VREF_6	AA2	VREF
6	N.C. (◆)	IO_L09P_6	IO_L09P_6	IO_L09P_6	IO_L09P_6	AA1	I/O
6	N.C. (◆)	IO_L10N_6	IO_L10N_6	IO_L10N_6	IO_L10N_6	Y2	I/O
6	N.C. (◆)	IO_L10P_6	IO_L10P_6	IO_L10P_6	IO_L10P_6	Y1	I/O
6	IO_L14N_6	IO_L14N_6	IO_L14N_6	IO_L14N_6	IO_L14N_6	W7	I/O
6	IO_L14P_6	IO_L14P_6	IO_L14P_6	IO_L14P_6	IO_L14P_6	W6	I/O
6	IO_L16N_6	IO_L16N_6	IO_L16N_6	IO_L16N_6	IO_L16N_6	V6	I/O
6	IO_L16P_6	IO_L16P_6	IO_L16P_6	IO_L16P_6	IO_L16P_6	W5	I/O
6	IO_L17N_6	IO_L17N_6	IO_L17N_6	IO_L17N_6	IO_L17N_6	W4	I/O
6	IO_L17P_6/VREF_6	IO_L17P_6/VREF_6	IO_L17P_6/VREF_6	IO_L17P_6/VREF_6	IO_L17P_6/VREF_6	W3	VREF
6	IO_L19N_6	IO_L19N_6	IO_L19N_6	IO_L19N_6	IO_L19N_6	W2	I/O
6	IO_L19P_6	IO_L19P_6	IO_L19P_6	IO_L19P_6	IO_L19P_6	W1	I/O

Table 103: **FG676 Package Pinout *(Cont'd)***

Bank	XC3S1000 Pin Name	XC3S1500 Pin Name	XC3S2000 Pin Name	XC3S4000 Pin Name	XC3S5000 Pin Name	FG676 Pin Number	Type
N/A	GND	GND	GND	GND	GND	D15	GND
N/A	GND	GND	GND	GND	GND	D23	GND
N/A	GND	GND	GND	GND	GND	K11	GND
N/A	GND	GND	GND	GND	GND	K12	GND
N/A	GND	GND	GND	GND	GND	K15	GND
N/A	GND	GND	GND	GND	GND	K16	GND
N/A	GND	GND	GND	GND	GND	L10	GND
N/A	GND	GND	GND	GND	GND	L11	GND
N/A	GND	GND	GND	GND	GND	L12	GND
N/A	GND	GND	GND	GND	GND	L13	GND
N/A	GND	GND	GND	GND	GND	L14	GND
N/A	GND	GND	GND	GND	GND	L15	GND
N/A	GND	GND	GND	GND	GND	L16	GND
N/A	GND	GND	GND	GND	GND	L17	GND
N/A	GND	GND	GND	GND	GND	M4	GND
N/A	GND	GND	GND	GND	GND	M10	GND
N/A	GND	GND	GND	GND	GND	M11	GND
N/A	GND	GND	GND	GND	GND	M12	GND
N/A	GND	GND	GND	GND	GND	M13	GND
N/A	GND	GND	GND	GND	GND	M14	GND
N/A	GND	GND	GND	GND	GND	M15	GND
N/A	GND	GND	GND	GND	GND	M16	GND
N/A	GND	GND	GND	GND	GND	M17	GND
N/A	GND	GND	GND	GND	GND	M23	GND
N/A	GND	GND	GND	GND	GND	N11	GND
N/A	GND	GND	GND	GND	GND	N12	GND
N/A	GND	GND	GND	GND	GND	N13	GND
N/A	GND	GND	GND	GND	GND	N14	GND
N/A	GND	GND	GND	GND	GND	N15	GND
N/A	GND	GND	GND	GND	GND	N16	GND
N/A	GND	GND	GND	GND	GND	P11	GND
N/A	GND	GND	GND	GND	GND	P12	GND
N/A	GND	GND	GND	GND	GND	P13	GND
N/A	GND	GND	GND	GND	GND	P14	GND
N/A	GND	GND	GND	GND	GND	P15	GND
N/A	GND	GND	GND	GND	GND	P16	GND
N/A	GND	GND	GND	GND	GND	R4	GND
N/A	GND	GND	GND	GND	GND	R10	GND
N/A	GND	GND	GND	GND	GND	R11	GND
N/A	GND	GND	GND	GND	GND	R12	GND
N/A	GND	GND	GND	GND	GND	R13	GND
N/A	GND	GND	GND	GND	GND	R14	GND
N/A	GND	GND	GND	GND	GND	R15	GND

Table 107: **FG900 Package Pinout *(Cont'd)***

Bank	XC3S2000 Pin Name	XC3S4000, XC3S5000 Pin Name	FG900 Pin Number	Type
N/A	GND	GND	R17	GND
N/A	GND	GND	T17	GND
N/A	GND	GND	U17	GND
N/A	GND	GND	V17	GND
N/A	GND	GND	AC17	GND
N/A	GND	GND	AF17	GND
N/A	GND	GND	AK17	GND
N/A	GND	GND	N18	GND
N/A	GND	GND	P18	GND
N/A	GND	GND	R18	GND
N/A	GND	GND	T18	GND
N/A	GND	GND	U18	GND
N/A	GND	GND	V18	GND
N/A	GND	GND	R19	GND
N/A	GND	GND	T19	GND
N/A	GND	GND	A21	GND
N/A	GND	GND	E21	GND
N/A	GND	GND	H21	GND
N/A	GND	GND	AC21	GND
N/A	GND	GND	AF21	GND
N/A	GND	GND	AK21	GND
N/A	GND	GND	K23	GND
N/A	GND	GND	P23	GND
N/A	GND	GND	U23	GND
N/A	GND	GND	AA23	GND
N/A	GND	GND	A25	GND
N/A	GND	GND	AK25	GND
N/A	GND	GND	E26	GND
N/A	GND	GND	K26	GND
N/A	GND	GND	P26	GND
N/A	GND	GND	U26	GND
N/A	GND	GND	AA26	GND
N/A	GND	GND	AF26	GND
N/A	GND	GND	A29	GND
N/A	GND	GND	B29	GND
N/A	GND	GND	AJ29	GND
N/A	GND	GND	AK29	GND
N/A	GND	GND	A30	GND
N/A	GND	GND	B30	GND
N/A	GND	GND	F30	GND

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
2	IO_L41N_2	IO_L41N_2	F33	I/O
2	IO_L41P_2	IO_L41P_2	F34	I/O
2	N.C. (◆)	IO_L42N_2	G31	I/O
2	N.C. (◆)	IO_L42P_2	G32	I/O
2	IO_L45N_2	IO_L45N_2	L33	I/O
2	IO_L45P_2	IO_L45P_2	L34	I/O
2	IO_L46N_2	IO_L46N_2	M24	I/O
2	IO_L46P_2	IO_L46P_2	M25	I/O
2	IO_L47N_2	IO_L47N_2	M27	I/O
2	IO_L47P_2	IO_L47P_2	M28	I/O
2	IO_L48N_2	IO_L48N_2	M33	I/O
2	IO_L48P_2	IO_L48P_2	M34	I/O
2	N.C. (◆)	IO_L49N_2	P25	I/O
2	N.C. (◆)	IO_L49P_2	P26	I/O
2	IO_L50N_2	IO_L50N_2	P27	I/O
2	IO_L50P_2	IO_L50P_2	P28	I/O
2	N.C. (◆)	IO_L51N_2	T24	I/O
2	N.C. (◆)	IO_L51P_2	U24	I/O
2	VCCO_2	VCCO_2	D32	VCCO
2	VCCO_2	VCCO_2	H28	VCCO
2	VCCO_2	VCCO_2	H32	VCCO
2	VCCO_2	VCCO_2	L27	VCCO
2	VCCO_2	VCCO_2	L31	VCCO
2	VCCO_2	VCCO_2	N23	VCCO
2	VCCO_2	VCCO_2	N29	VCCO
2	VCCO_2	VCCO_2	N33	VCCO
2	VCCO_2	VCCO_2	P23	VCCO
2	VCCO_2	VCCO_2	R23	VCCO
2	VCCO_2	VCCO_2	R27	VCCO
2	VCCO_2	VCCO_2	T23	VCCO
2	VCCO_2	VCCO_2	T31	VCCO
3	IO	IO	AH33	I/O
3	IO	IO	AH34	I/O
3	IO	IO	V25	I/O
3	IO	IO	V26	I/O
3	IO_L01N_3/VRP_3	IO_L01N_3/VRP_3	AM34	DCI
3	IO_L01P_3/VRN_3	IO_L01P_3/VRN_3	AM33	DCI
3	IO_L02N_3/VREF_3	IO_L02N_3/VREF_3	AL34	VREF
3	IO_L02P_3	IO_L02P_3	AL33	I/O
3	IO_L03N_3	IO_L03N_3	AK33	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
7	IO_L01P_7/VRN_7	IO_L01P_7/VRN_7	C2	DCI
7	IO_L02N_7	IO_L02N_7	D1	I/O
7	IO_L02P_7	IO_L02P_7	D2	I/O
7	IO_L03N_7/VREF_7	IO_L03N_7/VREF_7	E2	VREF
7	IO_L03P_7	IO_L03P_7	E3	I/O
7	IO_L04N_7	IO_L04N_7	F3	I/O
7	IO_L04P_7	IO_L04P_7	F4	I/O
7	IO_L05N_7	IO_L05N_7	F1	I/O
7	IO_L05P_7	IO_L05P_7	F2	I/O
7	IO_L06N_7	IO_L06N_7	G5	I/O
7	IO_L06P_7	IO_L06P_7	G6	I/O
7	IO_L07N_7	IO_L07N_7	H5	I/O
7	IO_L07P_7	IO_L07P_7	H6	I/O
7	IO_L08N_7	IO_L08N_7	H1	I/O
7	IO_L08P_7	IO_L08P_7	H2	I/O
7	IO_L09N_7	IO_L09N_7	J6	I/O
7	IO_L09P_7	IO_L09P_7	J7	I/O
7	IO_L10N_7	IO_L10N_7	J4	I/O
7	IO_L10P_7/VREF_7	IO_L10P_7/VREF_7	H4	VREF
7	IO_L11N_7	IO_L11N_7	J2	I/O
7	IO_L11P_7	IO_L11P_7	J3	I/O
7	IO_L12N_7	IO_L12N_7	K9	I/O
7	IO_L12P_7	IO_L12P_7	J8	I/O
7	IO_L13N_7	IO_L13N_7	K7	I/O
7	IO_L13P_7	IO_L13P_7	K8	I/O
7	IO_L14N_7	IO_L14N_7	K5	I/O
7	IO_L14P_7	IO_L14P_7	K6	I/O
7	IO_L15N_7	IO_L15N_7	K3	I/O
7	IO_L15P_7	IO_L15P_7	K4	I/O
7	IO_L16N_7	IO_L16N_7	K1	I/O
7	IO_L16P_7/VREF_7	IO_L16P_7/VREF_7	K2	VREF
7	IO_L17N_7	IO_L17N_7	L9	I/O
7	IO_L17P_7	IO_L17P_7	L10	I/O
7	IO_L19N_7/VREF_7	IO_L19N_7/VREF_7	L1	VREF
7	IO_L19P_7	IO_L19P_7	L2	I/O
7	IO_L20N_7	IO_L20N_7	M10	I/O
7	IO_L20P_7	IO_L20P_7	M11	I/O
7	IO_L21N_7	IO_L21N_7	M7	I/O
7	IO_L21P_7	IO_L21P_7	M8	I/O
7	IO_L22N_7	IO_L22N_7	M5	I/O

Table 110: **FG1156 Package Pinout *(Cont'd)***

Bank	XC3S4000 Pin Name	XC3S5000 Pin Name	FG1156 Pin Number	Type
N/A	GND	GND	Y14	GND
N/A	GND	GND	Y15	GND
N/A	GND	GND	Y16	GND
N/A	GND	GND	Y17	GND
N/A	GND	GND	Y18	GND
N/A	GND	GND	Y19	GND
N/A	GND	GND	Y20	GND
N/A	GND	GND	Y21	GND
N/A	N.C. (◆)	N.C. (■)	AK31	N.C.
N/A	VCCAUX	VCCAUX	AD30	VCCAUX
N/A	VCCAUX	VCCAUX	AD5	VCCAUX
N/A	VCCAUX	VCCAUX	AG16	VCCAUX
N/A	VCCAUX	VCCAUX	AG19	VCCAUX
N/A	VCCAUX	VCCAUX	AJ30	VCCAUX
N/A	VCCAUX	VCCAUX	AJ5	VCCAUX
N/A	VCCAUX	VCCAUX	AK11	VCCAUX
N/A	VCCAUX	VCCAUX	AK15	VCCAUX
N/A	VCCAUX	VCCAUX	AK20	VCCAUX
N/A	VCCAUX	VCCAUX	AK24	VCCAUX
N/A	VCCAUX	VCCAUX	AK29	VCCAUX
N/A	VCCAUX	VCCAUX	AK6	VCCAUX
N/A	VCCAUX	VCCAUX	E11	VCCAUX
N/A	VCCAUX	VCCAUX	E15	VCCAUX
N/A	VCCAUX	VCCAUX	E20	VCCAUX
N/A	VCCAUX	VCCAUX	E24	VCCAUX
N/A	VCCAUX	VCCAUX	E29	VCCAUX
N/A	VCCAUX	VCCAUX	E6	VCCAUX
N/A	VCCAUX	VCCAUX	F30	VCCAUX
N/A	VCCAUX	VCCAUX	F5	VCCAUX
N/A	VCCAUX	VCCAUX	H16	VCCAUX
N/A	VCCAUX	VCCAUX	H19	VCCAUX
N/A	VCCAUX	VCCAUX	L30	VCCAUX
N/A	VCCAUX	VCCAUX	L5	VCCAUX
N/A	VCCAUX	VCCAUX	R30	VCCAUX
N/A	VCCAUX	VCCAUX	R5	VCCAUX
N/A	VCCAUX	VCCAUX	T27	VCCAUX
N/A	VCCAUX	VCCAUX	T8	VCCAUX
N/A	VCCAUX	VCCAUX	W27	VCCAUX
N/A	VCCAUX	VCCAUX	W8	VCCAUX
N/A	VCCAUX	VCCAUX	Y30	VCCAUX

Date	Version	Description
11/30/07	2.3	Added XC3S5000 FG(G)676 package. Noted that the FG(G)1156 package is being discontinued. Updated Table 86 with latest thermal characteristics data.
06/25/08	2.4	Updated formatting and links.
12/04/09	2.5	Added link to UG332 in CCLK: Configuration Clock. Noted that the CP132, CPG132, FG1156, and FGG1156 packages are being discontinued in Table 81, Table 83, Table 84, Table 85, and Table 86. Updated CP132: 132-Ball Chip-Scale Package to indicate that the CP132 and CPG132 packages are being discontinued.
10/29/12	3.0	Added Notice of Disclaimer. Per XCN07022, updated the FG1156 and FGG1156 package discussion throughout document including in Table 81, Table 83, Table 84, Table 85, and Table 86. Per XCN08011, updated CP132 and CPG132 package discussion throughout document including in Table 81, Table 83, Table 84, Table 85, and Table 86. This product is not recommended for new designs.

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